

January 1989 Revised May 1999

## 74F403A

## First-In First-Out (FIFO) Buffer Memory

## **General Description**

The 74F403A is an expandable fall-through type high-speed First-In First-Out (FIFO) Buffer Memory optimized for high-speed disk or tape controllers and communication buffer applications. It is organized as 16-words by 4-bits and may be expanded to any number of words or any number of bits in multiples of four. Data may be entered or extracted asynchronously in serial or parallel, allowing economical implementation of buffer memories.

The 74F403A has 3-STATE outputs which provide added versatility and is fully compatible with all TTL families.

#### **Features**

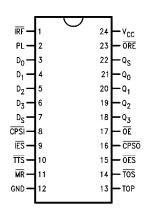
- Serial or parallel input
- Serial or parallel output
- Expandable without external logic
- 3-STATE outputs
- Fully compatible with all TTL families
- Slim 24-pin package
- 9403A replacement
- Guaranteed 4000V minimum ESD protection

## **Ordering Code:**

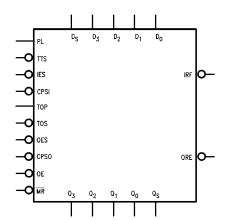
Order Number	Package Number	Package Description
74F403ASPC	N24C	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-100, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

## **Connection Diagram**



## **Logic Symbol**

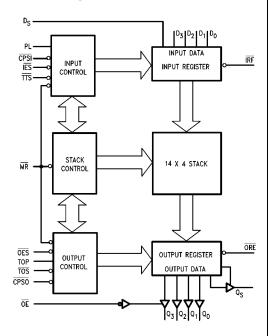


## **Unit Loading/Fan Out:**

See Section 2 for U.L. definitions

Pin	December	U.L.	Input I <sub>IH</sub> /I <sub>IL</sub>		
Names	Description	HIGH/LOW	Output I <sub>OH</sub> /I <sub>OL</sub>		
$D_0 - D_3$	Parallel Data Inputs	1.0/0.667	20 μΑ/400 μΑ		
D <sub>S</sub>	Serial Data Input	1.0/0.667	20 μΑ/400 μΑ		
PL	Parallel Load Input	1.0/0.667	20 μΑ/400 μΑ		
CPSI	Serial Input Clock	1.0/0.667	20 μΑ/400 μΑ		
ĪĒS	Serial Input Enable	1.0/0.667	20 μΑ/400 μΑ		
TTS	Transfer to Stack Input	1.0/0.667	20 μΑ/400 μΑ		
OES	Serial Output Enable	1.0/0.667	20 μΑ/400 μΑ		
TOS	Transfer Out Serial	1.0/0.667	20 μΑ/400 μΑ		
TOP	Transfer Out Parallel	1.0/0.667	20 μΑ/400 μΑ		
MR	Master Reset	1.0/0.667	20 μΑ/400 μΑ		
ŌĒ	Output Enable	1.0/0.667	20 μΑ/400 μΑ		
CPSO	Serial Output Clock	1.0/0.667	20 μΑ/400 μΑ		
$Q_0 - Q_3$	Parallel Data Outputs	285/26.7	5.7 mA/16 mA		
Q <sub>S</sub>	Serial Data Output	285/26.7	5.7 mA/16 mA		
ĪRF	Input Register Full	20/13.3	-400 μA/8 mA		
ORE	Output Register Empty	20/13.3	–400 μA/8 mA		

## **Block Diagram**



## **Functional Description**

As shown in the Block Diagram the 74F403A consists of three sections:

- An Input register with parallel and serial data inputs as well as control inputs and outputs for input handshaking and expansion.
- A 4-bit wide, 14-word deep fall-through stack with selfcontained control logic.
- An Output Register with parallel and serial data outputs as well as control inputs and outputs for output handshaking and expansion.

Since these three sections operate asynchronously and almost independently, they will be described separately below.

#### **INPUT REGISTER (DATA ENTRY)**

The Input Register can receive data in either bit-serial or in 4-bit parallel form. It stores this data until it is sent to the fall-through stack and generates the necessary status and control signals.

Figure 1 is a conceptual logic diagram of the input section. As described later, this 5-bit register is initialized by setting

the  $F_3$  flip-flop and resetting the other flip-flops. The  $\overline{Q}$  output of the last flip-flop (FC) is brought out as the "Input Register Full" output (IRF). After initialization this output is HIGH.

**Parallel Entry**— A HIGH on the PL input loads the  $D_0$ - $D_3$  inputs into the  $F_0$ - $F_3$  flip-flops and sets the FC flip-flop. This forces the  $\overline{\text{IRF}}$  output LOW indicating that the input register is full. During parallel entry, the  $\overline{\text{CPSI}}$  input must be LOW. If parallel expansion is not being implemented,  $\overline{\text{IES}}$  must be LOW to establish row mastership (see Expansion section).

**Serial Entry**— Data on the  $D_S$  input is serially entered into the  $F_3$ ,  $F_2$ ,  $F_1$ ,  $F_0$ , FC shift register on each HIGH-to-LOW transition of the  $\overline{CPSI}$  clock input, provided  $\overline{IES}$  and PL are I OW

After the fourth clock transition, the four data bits are located in the four flip-flops,  $F_0\text{-}F_3.$  The FC flip-flop is set, forcing the  $\overline{IRF}$  output LOW and internally inhibiting  $\overline{CPSI}$  clock pulses from affecting the register, Figure 2 illustrates the final positions in a 74F403A resulting from a 64-bit serial bit train.  $B_0$  is the first bit,  $B_{63}$  the last bit.

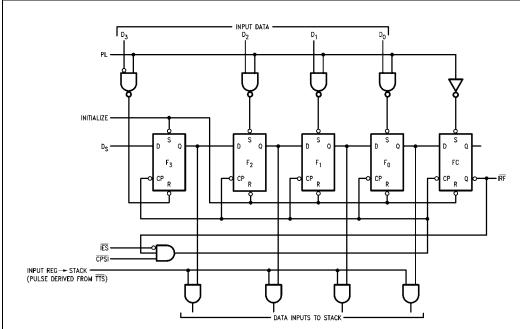


FIGURE 1. Conceptual Input Section

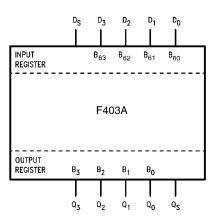


FIGURE 2. Final Positions in a 74F403A Resulting from a 64-Bit Serial Train

**Transfer to the Stack**— The outputs of Flip-Flops  $F_0$ - $F_3$  feed the stack. A LOW level on the  $\overline{TTS}$  input initiates a "fall-through" action. If the top location of the stack is empty, data is loaded into the stack and the input register is re-initialized. Note that this initialization is postponed until PL is LOW again.  $\overline{Thus}$ , automatic  $\overline{FIFO}$  action is achieved by connecting the  $\overline{IRF}$  output to the  $\overline{TTS}$  input.

An RS Flip-Flop (the Request Initialization Flip-Flop shown in Figure 10) in the control section records the fact that data has been transferred to the stack. This prevents multiple entry of the same word into the stack despite the fact the IRF and  $\overline{\text{TTS}}$  may still be LOW. The Request Initialization Flip-Flop is not cleared until PL goes LOW. Once in the stack, data falls through the stack automatically, pausing only when it is necessary to wait for an empty next location. In the 74F403A as in most modern FIFO designs, the  $\overline{\text{MR}}$  input only initializes the stack control section and does not clear the data.

#### **OUTPUT REGISTER (DATA EXTRACTION)**

The Output Register receives 4-bit data words from the bottom stack location, stores it and outputs data on a 3-STATE 4-bit parallel data bus or on a 3-STATE serial data bus. The output section generates and receives the necesary status and control signals. Figure 3 is a conceptual logic diagram of the output section.

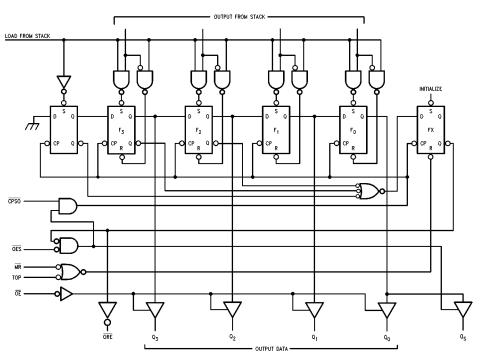


FIGURE 3. Conceptual Output Section

Parallel Data Extraction— When the FIFO is empty after a LOW pulse is applied to MR, the Output Register Empty (ORE) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided the "Transfer Out Parallel" (TOP) input is HIGH. As a result of the data transfer ORE goes HIGH, indicating valid data on the data outputs (provided the 3-STATE buffer is enabled). TOP can now be used to clock out the next word. When TOP goes LOW, ORE will go LOW indicating that the output data has been extracted, but the data itself remains on the output bus until the next HIGH level at TOP permits the transfer of the next word (if available) into the Output Register. During parallel data extraction CPSO should be LOW. TOS should be grounded for single slice operation or connected to the appropriate ORE for expanded operation (see Expansion section).

TOP is not edge triggered. Therefore, if TOP goes HIGH before data is available from the stack, but data does become available before TOP goes LOW again, that data will be transferred into the Output Register. However, internal control circuitry prevents the same data from being

transferred twice. If TOP goes HIGH and returns to LOW before data is available from the stack,  $\overline{\text{ORE}}$  remains LOW indicating that there is no valid data at the outputs.

**Serial Data Extraction—** When the FIFO is empty after a  $\underline{LOW}$  pulse is applied to  $\overline{MR}$ , the Output Register empty (ORE) output is LOW. After data has been entered into the FIFO and has fallen through to the bottom stack location, it is transferred into the Output Register provided TOS is LOW and TOP is HIGH. As a result of the data transfer ORE goes HIGH indicating valid data in the register. The 3-STATE Serial Data Output,  $Q_{S}$ , is automatically enabled and puts the first data bit on the output bus. Data is serially shifted out on the HIGH-to-LOW transition of CPSO. To prevent false shifting, CPSO should be LOW when the new word is being loaded into the Output Register. The fourth transition empties the shift register, forces ORE output LOW and disables the serial output,  $Q_S$  (refer to Figure 3). For serial operation the ORE output may be tied to the TOS input, requesting a new word from the stack as soon as the previous one has been shifted out.

#### **EXPANSION**

**Vertical Expansion**— The 74F403A may be vertically expanded to store more words without external parts. The interconnection is necessary to form a 46-word by 4-bit FIFO are shown in Figure 4. Using the same technique, and FIFO of (15n + 1)-words by 4-bits can be constructed, where n is the number of devices. Note that expansion does not sacrifice any of the 74F403A's flexibility for serial/parallel input and output.

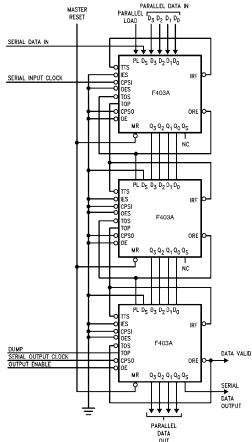


FIGURE 4. A Vertical Expansion Scheme

Horizontal and Vertical Expansion— The 74F403A can be expanded in both the horizontal and vertical directions without any external parts and without sacrificing any of its FIFO's flexibility for serial/parallel input and output. The interconnections necessary to form a 31-word by 16-bit FIFO are shown in Figure 6. Using the same technique, any FIFO of (15m + 1)-words by (4n)-bits can be constructed, where m is the number of devices in a column and n is the number of devices in a row. Figure 7 and Figure 8 show the timing diagrams for serial data entry and extraction for the 31-word by 16-bit FIFO shown in Figure 6. The final position of data after serial insertion of 496 bits into the FIFO array of Figure 6 is shown in Figure 9.

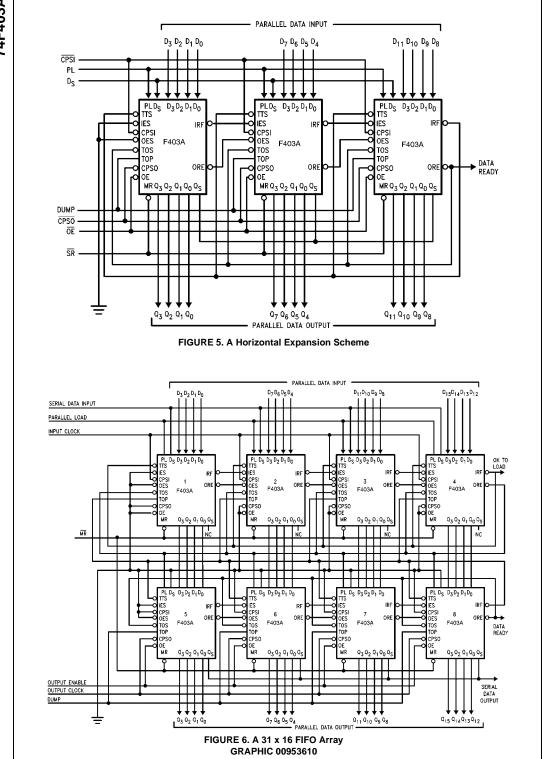
Interlocking Circuitry— Most conventional FIFO designs provide status signals analogous to IRF and ORE. However, when these devices are operated in arrays, variations in unit to unit operating speed require external gating to assure all devices have completed an operation. The 74F403A incorporates simple but effective "master/slave" interlocking circuitry to eliminate the need for external gating.

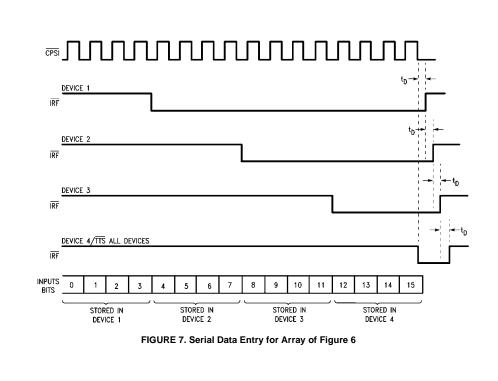
In the 74F403A array of Figure 6 devices 1 and 5 are defined as "row masters" and the other devices are slaves to the master in their row. No slave in a given row will initialize its Input Register until it has received LOW on its  $\overline{\text{IES}}$  input from a row master or a slave of higher priority.

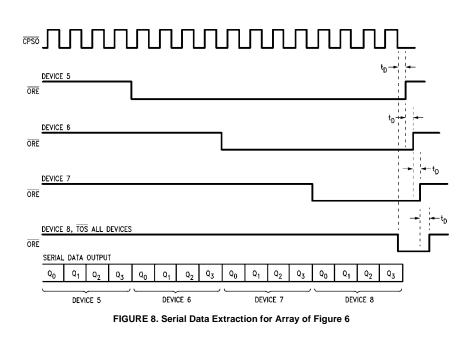
In a similar fashion, the  $\overline{ORE}$  outputs of slaves will not go HIGH until their  $\overline{OES}$  inputs have gone HIGH. This interlocking scheme ensures that new input data may be accepted by the array when the  $\overline{IRF}$  output of the final slave in that row goes HIGH and that output data for the array may be extracted when the  $\overline{ORE}$  of the final slave in the output row goes HIGH.

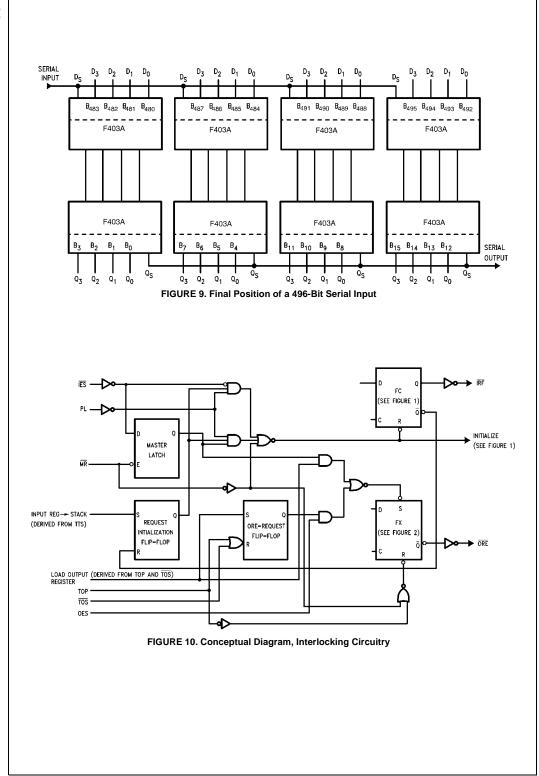
The row master is established by connecting its IES input to ground while a slave receives its IES input from the IRF output of the next higher priority device. When an array of 74F403A FIFOs is initialized with a LOW on the MR inputs of all devices, the  $\overline{\mbox{IRF}}$  outputs of all devices will be HIGH. Thus, only the row master receives a LOW on the IES input during initialization. Figure 10 is a conceptual logic diagram of the internal circuitry which determines master/slave operation. Whenever MR and IES are LOW, the Master Latch is set. Whenever TTS goes LOW the Request Initialization Flip-Flop will be set. If the Master Latch is HIGH, the Input Register will be immediately initialized and the Request Initialization Flip-Flop reset. If the Master Latch is reset, the Input Register is not initialized until IES goes LOW. In array operation, activating the TTS initiates a ripple input register initialization from the row master to the

A similar operation takes place for the output register. Either a  $\overline{TOS}$  or  $\overline{TOP}$  input initiates a load-from-stack operation and sets the  $\overline{ORE}$  Request Flip-Flop. If the Master Latch is set, the last Output Register Flip-Flop is set and  $\overline{ORE}$  goes HIGH. If the Master Latch is reset, the  $\overline{ORE}$  output will be LOW until an  $\overline{OES}$  input is received.









## **Absolute Maximum Ratings**(Note 1)

Recommended Operating Conditions

 $\begin{array}{ll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \end{array}$ 

Junction Temperature under Bias -55°C to +175°C V<sub>CC</sub> Pin Potential to Ground Pin -0.5V to +7.0V

Input Voltage (Note 2) -0.5V to +7.0V
Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Output

In HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{3-STATE Output} & -0.5 \text{V to +5.5 V} \end{array}$ 

Current Applied to Output

Free Air Ambient Temperature  $0^{\circ}\text{C} \text{ to } +70^{\circ}\text{C}$ Supply Voltage +4.5V to +5.5V

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

## **DC Electrical Characteristics**

Symbol	Parameter		Min	Туре	Max	Units	v <sub>cc</sub>	Conditions
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal
V <sub>IL</sub>	Input LOW Voltage				8.0	V		Recognized as a LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage				-1.5	V	Min	I <sub>IN</sub> = -18 mA
V <sub>OH</sub>	Output HIGH	10% V <sub>CC</sub>	2.5					$I_{OH} = -400 \mu A (\overline{IRF}, \overline{ORE})$
	Voltage	10% V <sub>CC</sub>	2.5			V Min	$I_{OH} = -5.7 \text{ mA } (Q_n, Q_s)$	
		5% V <sub>CC</sub>	2.7			V		$I_{OH} = -400 \mu A (\overline{IRF}, \overline{ORE})$
		$5\% V_{CC}$	2.7					$I_{OH} = -5.7 \text{ mA } (Q_n, Q_s)$
V <sub>OL</sub>	Output LOW	10% V <sub>CC</sub>			0.5	V	Min	I <sub>OL</sub> = 8 mA (IRF, ORE)
	Voltage	10% V <sub>CC</sub>			0.5	V	IVIII	$I_{OL} = 16 \text{ mA } (Q_n, Q_s)$
I <sub>IH</sub>	Input HIGH Current				20	μΑ	Max	V <sub>IN</sub> = 2.7V
I <sub>BVI</sub>	Input HIGH Current				100	μА	Max	V <sub>IN</sub> = 7.0V
	Breakdown Test			100	μΑ	IVIAX	VIN - 7.0V	
I <sub>IL</sub>	Input LOW Current				-0.4	mA	Max	V <sub>IN</sub> = 0.5V
I <sub>OZH</sub>	Output Leakage Current				50	μΑ	Max	V <sub>OUT</sub> = 2.7V
I <sub>OZL</sub>	Output Leakage Current				-50	μΑ	Max	V <sub>OUT</sub> = 0.5V
Ios	Output Short-Circuit Current		-20		-130	mA	Max	V <sub>OUT</sub> = 0V
I <sub>CEX</sub>	Output HIGH Leakage Current				250	μΑ	Max	V <sub>OUT</sub> = V <sub>CC</sub>
I <sub>CCL</sub>	Power Supply Current				170	mA	Max	$V_0 = LOW$

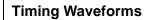
Symbol		T <sub>A</sub> =	+25°C	T <sub>A</sub> = 0° to +70°C		Ī	
		V <sub>CC</sub> =	+5.0V	V <sub>CC</sub> =	+5.0V		Figure
	Parameter	C <sub>L</sub> =	C <sub>L</sub> = 50 pF		50 pF	Units	Numbe
		Min	Max	Min	Max		
t <sub>PHL</sub>	Propagation Delay,						
	Negative-Going	7.5	14.0	7.0	15.0		
	CPSI to IRF Output						Figure
PLH	Propagation Delay,					ns	Figure
	Negative-Going	11.0	20.5	10.0	22.5		
	TTS to IRF						
PLH	Propagation Delay,	8.5	17.0	7.5	18.5		
PHL	Negative-Going	8.0	14.5	7.0	15.5	ns	Figure
	CPSO to Q <sub>S</sub> Output						Figure
PLH	Propagation Delay,	10.0	18.0	9.0	20.0		
PHL	Positive-Going	8.5	15.5	8.0	16.5	ns	Figure
PHL	TOP to Outputs Q <sub>0</sub> -Q <sub>3</sub>	0.0	10.0	0.0	10.0		gu.o
t <sub>PHL</sub>	Propagation Delay,						1
PHL	Negative-Going	9.5	17.5	9.0	19.0	ns	Figure
		9.5	17.5	9.0	19.0	115	Figure
	CPSO to ORE						
t <sub>PHL</sub>	Propagation Delay,		45.0		40.5		
	Negative-Going	8.0	15.0	7.5	16.5		
	TOP to ORE					ns	Figure
t <sub>PLH</sub>	Propagation Delay,						
	Positive-Going	12.5	22.0	11.5	25.0		
	TOP or ORE						
t <sub>PLH</sub>	Propagation Delay,						Fi
	Negative-Going	12.5	22.0	11.0	25.0	ns	Figure Figure
	TOS to Positive Going ORE						
t <sub>PHL</sub>	Propagation Delay,						
	Positive-Going	7.0	13.0	6.5	14.0		
	PL to Negative-Going IRF					ns	Figure
t <sub>PLH</sub>	Propagation Delay,					115	Figure
	Negative-Going	9.5	17.0	8.5	19.5		
	PL to Positive-Going IRF						
t <sub>PLH</sub>	Propagation Delay,						
	Apostatize-Going	10.0	18.0	9.0	20.5	ns	
	OES to ORE						
t <sub>PLH</sub>	Propagation Delay,						
701	Positive-Going	8.5	15.5	7.5	17.5	ns	Figure
	IES to Positive-Going IRF						3
tou	Propagation Delay,						
t <sub>PLH</sub>	MR to IRF	8.0	15.0	7.5	17.0	ns	
<b>+</b>	Propagation Delay,						
t <sub>PHL</sub>	MR to ORE	9.0	16.0	8.0	17.5	ns	
				0.0			
t <sub>PZH</sub>	Propagation Delay,	2.5	6.5	2.0	8.0		
t <sub>PZL</sub>	$\overline{OE}$ to $Q_0$ , $Q_1$ , $Q_2$ , $Q_3$	2.5	7.5	2.0	8.5	ns	
t <sub>PHZ</sub>	Propagation Delay,	2.5	6.5	2.0	8.0		
t <sub>PLZ</sub>	$\overline{OE}$ to $Q_0$ , $Q_1$ , $Q_2$ , $Q_3$	2.5	7.5	2.0	8.0		
<sup>t</sup> PZH	Propagation Delay,	5.5	12.0	5.0	15.0		
PZL	Negative-Going	5.5	14.0	5.0	15.0		
	OES to Q <sub>S</sub>					ns	
PHZ	Propagation Delay,	5.5	12.0	5.0	14.0	110	
t <sub>PLZ</sub>	Negative-Going	5.5	14.5	5.0	16.0		
	OES to Q <sub>S</sub>			1		1	1

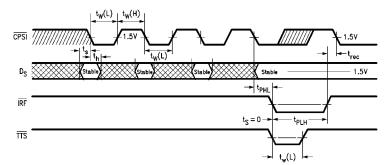
## AC Electrical Characteristics (Continued)

Symbol	Parameter	$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$ $C_L = 50 \text{ pF}$		$T_A = 0^{\circ} \text{ to } +70^{\circ}\text{C}$ $V_{CC} = +5.0\text{V}$ $C_L = 50 \text{ pF}$		Units	Figure Number
		Min	Max	Min	Max		ļ l
t <sub>PZH</sub>	Turn On Time	8.5	21.0	8.0	24.0	no	
t <sub>PZL</sub>	TOS to Q <sub>S</sub>	8.5	20.0	8.0	21.0	ns	
t <sub>DFT</sub>	Fall Through Time	45.0	80.0	35.0	95.0	ns	Figure 16
t <sub>AP</sub>	Parallel Appearance Time,  ORE to Q <sub>0</sub> -Q <sub>3</sub>	-10.0	-1.0	-10.0	-1.0	ns	
t <sub>AS</sub>	Serial Appearance Time,  ORE to Q <sub>S</sub>	-10.0	2.0	-10.0	20	113	

# **AC Operating Requirements**

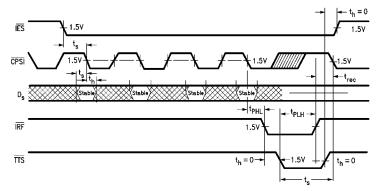
Symbol	Parameter	T <sub>A</sub> = +25°C	$T_A = 0$ °C to +70°C	Units	Figure Number
		$V_{CC} = +5.0V$	$\textbf{V}_{\textbf{CC}} = +5.0 \textbf{V}$		
		Min Max	Min Max		
t <sub>S</sub> (H)	Set-up Time HIGH or LOW	1.0	1.0		
$t_S(L)$	D <sub>S</sub> to Negative CPSI	1.0	1.0		Figure 11
t <sub>H</sub> (H)	Hold Time, HIGH or LOW	3.5	3.5	ns	Figure 12
$t_H(L)$	D <sub>S</sub> to CPSI	3.5	3.5		
t <sub>S</sub> (L)	Set-up Time, LOW				Figure 11
	TTS to IRF	0	0	ns	Figure 12 Figure 17
	Serial or Parallel Mode				Figure 18
t <sub>S</sub> (L)	Set-up Time, LOW				
	Negative-Going ORE to	0	0	ns	Figure 13 Figure 14
	Negative-Going TOS				Figure 14
t <sub>S</sub> (L)	Set-up Time, LOW			ns	Figure 12
-	Negative-Going IES to CPSI	3.0	4.0		
t <sub>S</sub> (L)	Set-up Time, LOW				
	Negative-Going TTS to CPSI	14.0	15.5	ns	Figure 12
t <sub>S</sub> (H)	Set-up Time, HIGH or LOW	0	0		
t <sub>S</sub> (L)	Parallel Inputs to PL	0	0		
t <sub>H</sub> (H)	Hold Time, HIGH or LOW	2.0	2.5	ns	
$t_H(L)$	Parallel Inputs to PL	2.0	2.5		
t <sub>W</sub> (H)	CPSI Pulse Width	5.0	6.0		Figure 11
$t_W(L)$	HIGH or LOW	3.0	5.0	ns	Figure 12
t <sub>W</sub> (H)	PL Pulse Width, HIGH	4.0	5.0	ns	Figure 17 Figure 18
t <sub>W</sub> (L)	TTS Pulse Width, LOW				Figure 11
	Serial or Parallel Mode	3.5	4.0	ns	Figure 12 Figure 13
					Figure 14
t <sub>W</sub> (L)	MR Pulse Width, LOW	3.5	4.0	ns	Figure 16
t <sub>W</sub> (H)	TOP Pulse Width	4.5	5.5		
t <sub>W</sub> (L)	HIGH or LOW	3.5	4.0	ns	Figure 15
t <sub>W</sub> (H)	CPSO Pulse Width	4.5	5.5		Figure 13
t <sub>W</sub> (L)	HIGH or LOW	3.0	4.0	ns	Figure 14
t <sub>REC</sub>	Recovery Time				+
	MR to Any Input	5.0	5.5	ns	Figure 16





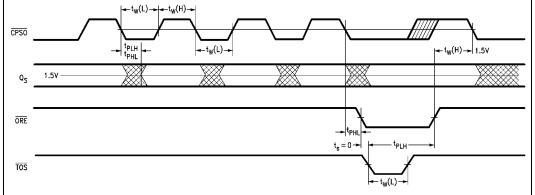
Conditions: stack not full,  $\overline{\text{IES}}$ , PL LOW

FIGURE 11. Serial Input, Unexpanded or Master Operation



Conditions: stack not full,  $\overline{\rm IES}$  HIGH when initiated, PL LOW

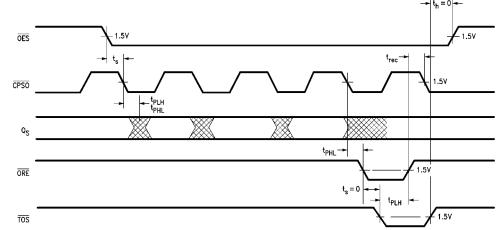
FIGURE 12. Serial Input, Expanded Slave Operation



Conditions: data in stack, TOP HIGH,  $\overline{\rm IES}$  LOW when initiated,  $\overline{\rm OES}$  LOW

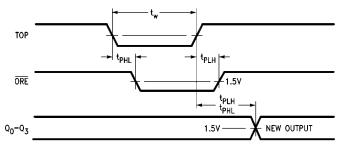
FIGURE 13. Serial Output, Unexpanded or Master Operation





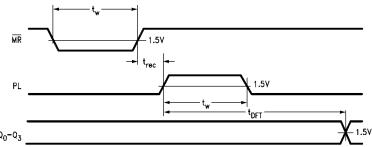
Conditions: data in stack, TOP HIGH,  $\overline{\text{IES}}$  HIGH when initiated

FIGURE 14. Serial Output, Slave Operation



Conditions:  $\overline{\text{IES}}$  LOW when initiated,  $\overline{\text{OE}}$ ,  $\overline{\text{CPSO}}$  LOW; data available in stack

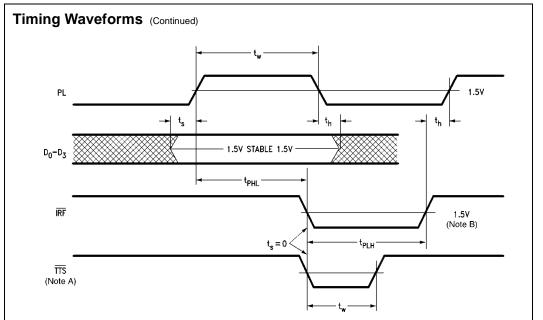
FIGURE 15. Parallel Output, 4-Bit Word or Master in Parallel Expansion



 $\textbf{Conditions: } \overline{\textbf{TTS}} \textbf{ connected to } \overline{\textbf{IRF}}, \overline{\textbf{TOS}} \textbf{ connected to } \overline{\textbf{ORE}}, \overline{\textbf{IES}}, \overline{\textbf{OES}}, \overline{\textbf{OE}}, \overline{\textbf{CPSO}} \textbf{ LOW, TOP HIGH}$ 

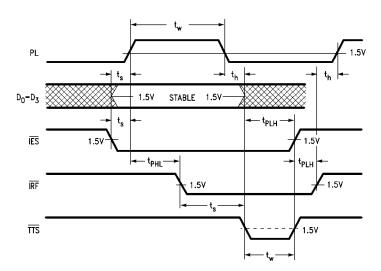
FIGURE 16. Fall Through Time





Conditions: stack not full,  $\overline{\text{IES}}$  LOW when initialized NOTE A: $\overline{\text{TTS}}$  normally connected to  $\overline{\text{IRF}}$ . NOTE B: If stack is full,  $\overline{\text{IRF}}$  will stay LOW.

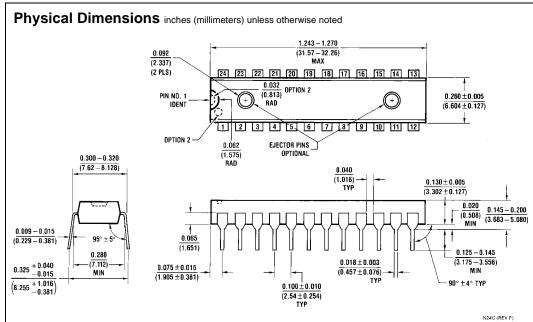
FIGURE 17. Parallel Load Mode, 4-Bit Word (Unexpanded) or Master in Parallel Expansion



Conditions: stack not full, device initialized (Note 3) with  $\overline{\text{IES}}\ \text{HIGH}$ 

#### FIGURE 18. Parallel Load, Slave Mode

Note 3: Initialization requires a master reset to occur after power has been applied.



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-100, 0.300 Wide Package Number N24C

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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